

Electronic Acknowledgement Receipt

EFS ID:	1353572
Application Number:	10792069
International Application Number:	
Confirmation Number:	4228
Title of Invention:	Integrated multi-step gap fill and all feature planarization for conductive materials
First Named Inventor/Applicant Name:	Wei-Yung Hsu
Customer Number:	44257
Filer:	Keith M. Tackett/Tammi Thomas
Filer Authorized By:	Keith M. Tackett
Attorney Docket Number:	AMAT/5614.D1/CMP/CMP/RKK
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Application Type:	Utility

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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed	005614D1_SIDS_EF.pdf	674299	no	4

Warnings:

Information:**Total Files Size (in bytes):**

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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.